

THE CONFERENCE

The semiconductor industry faces significant challenges to continue increasing performance and functionality of information processing. New and improved metrology and characterization is required to support these advances in density and functionality. We bring together scientists and engineers interested in all aspects of the characterization technology needed for nanoelectronic materials and device research, development, and manufacturing. All approaches are welcome: chemical, physical, electrical, optical, in-situ, and real-time control and monitoring. The conference summarizes major issues and provides critical reviews of important semiconductor techniques needed as the semiconductor industry moves to silicon nanoelectronics and beyond.

The conference will consist of formal invited presentation sessions and poster sessions for contributed papers. The poster papers should cover new developments in characterization and metrology especially at the nanoscale.



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Committee Members

Luigi Colombo, TI
Michael Current, Current Scientific
Bob Havemann, SRC
Dick Hockett, Evans Analytical Group Ltd
Toshihiko Kanayama, AIST
David Kyser, Applied Materials
Shifeng Lu, Micron
Zhiyong Ma, Intel
Ulrich Mantz, Zeiss
Lori S. Nye, Brewer Science, Inc.
Yaw Obeng, NIST
Erik Secula, NIST
Sandip Tiwari, Cornell University
Victor Vartanian, ISMI
Wilfried Vandervorst, IMEC
Usha Varshney, NSF
Ehrenfried Zschech, Fraunhofer Institute for Non-Destructive Testing

Committee Co-Chairs

David Seiler, NIST
Alain Diebold, CNSE, University at Albany
Bob McDonald, formerly of Intel (Treasurer)
George Thompson, Intel
Amal Chabli, CEA-LETI

General Information Contact

Lori Guariglia
Phone: (301) 975-2054
e-mail: lori.guariglia@nist.gov

Publications Contact

Erik Secula
Phone: (301) 975-2050
e-mail: erik.secula@nist.gov

Technical Contact

David Seiler
Phone: (301) 975-2074
e-mail: david.seiler@nist.gov

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FIRST ANNOUNCEMENT



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2013 INTERNATIONAL CONFERENCE ON FRONTIERS OF CHARACTERIZATION AND METROLOGY FOR NANOELECTRONICS (FCMN)

MARCH 25-28, 2013
GAITHERSBURG, MD

NATIONAL INSTITUTE
OF STANDARDS AND
TECHNOLOGY



www.nist.gov/pml/div683/conference/

CALL FOR PAPERS

Papers are solicited to address materials and device characterization and metrology for:

- ✦ 300 mm
- ✦ Alternative Gate Dielectrics
- ✦ Beyond CMOS
- ✦ Breakthroughs in Electron Microscopy
- ✦ Breakthroughs in Lithography
- ✦ Channel Engineering (e.g., strained silicon, 3/5s)
- ✦ Contamination, Detection, and Identification
- ✦ Critical Analytical Techniques
- ✦ Defects
- ✦ Device Manufacturing
- ✦ Diagnostics
- ✦ Embedded or Buried Interfaces
- ✦ In-Situ, Real-Time Control and Monitoring
- ✦ Integrated Metrology
- ✦ Interconnects; Present or Future
- ✦ Lab-on-a-Chip
- ✦ MEMS/NEMS Metrology Applications
- ✦ Modeling/Simulation
- ✦ Nanoelectronics Materials and Devices
- ✦ Non-Destructive Atomic Scale Methods
- ✦ Novel Measurement Methods, Breakthroughs
- ✦ Thin-Films
- ✦ Ultra-Shallow Junctions
- ✦ Wafer Fab
- ✦ Wafer Manufacturing and New Substrate Materials

HOTEL DETAILS

A block of rooms is reserved at a special conference rate at the Crown Plaza Hotel in Rockville, MD. Additional details will be available soon.

ABSTRACTS

Camera-ready abstracts must be received by Nov. 13, 2012. The template will be available soon in the "Author Instructions" section of the conference website. The cover page must include the name, address, telephone and fax numbers, and e-mail address of the contact author. Please include three key words that best describe your paper at the end of the abstract. Also, you are encouraged to provide at least one figure presenting data. Notice of acceptance of papers will be given by Dec. 19, 2012.

Address all abstracts to the conference publications coordinator, Erik Secula (erik.secula@nist.gov). Please send Microsoft Word or Adobe PDF files. If e-mail is not a practical option, please contact Erik Secula at (301) 975-2050 to make alternative arrangements.

MANUSCRIPTS

It is considered crucial to the success of the conference that all papers be published in a special proceedings. The deadline for submission of camera-ready manuscripts will be before the conference.

All manuscripts will be reviewed before acceptance. Instructions for manuscript preparation will be provided when notification of accepted abstracts is given to the authors.

REGISTRATION

The registration fee for the conference includes coffee breaks, lunches, a banquet, an extended abstract booklet, and the workshop proceedings, along with a CD-ROM. All payments for advanced and student registration must be received by Feb. 28, 2013. Online registration will be available soon.

BACKGROUND

With the semiconductor industry moving beyond standard silicon and further into nanoelectronics, the introduction of new materials and novel devices using innovative processing and assembly brings formidable metrology challenges. We are in an era where nanotechnology is driving us toward ever smaller, faster, cheaper, and more complex devices. Innovative metrology and characterization methods are required.

The 2013 FCMN is the ninth in a series that began in 1995. It emphasizes the frontiers and innovation in characterization and metrology of nanoelectronics. The proceedings for all eight previous conferences were published as hardcover volumes by the American Institute of Physics, New York. The most recent proceedings, *Frontiers of Characterization and Metrology for Nanoelectronics: 2011*, was published in Dec. 2011 and is available for purchase at proceedings.aip.org/resource/2/apcpcs/1395/1. The proceedings for most of the other entries are available free-of-charge at www.nist.gov/pml/div683/conference/archives.cfm.